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**FACSIMILE COVER SHEET**

To: Examiner Douglas W. Owens	Total Pages Sent: 28
Technology Center 2800	(including cover sheet)
Facsimile Number: (571) 273-8300	Transmission Date: March 15, 2006

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Huang, *et al.* Docket No.: TSM03-0340  
Serial No: 10/706,156 Art Unit: 2811  
Date Filed: November 12, 2003  
Title: Integration Film Scheme for Copper / Low-k Interconnect

**CERTIFICATION OF FACSIMILE TRANSMISSION**

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at (571) 273-8300 on the date shown above:

- Certification of Facsimile Transmission (1 page)
- Amendment Transmittal Letter (2 duplicate pages)
- Amendment (25 pages)

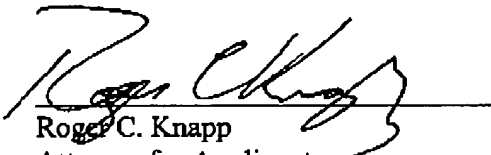
Respectfully submitted,



Kristin R. Hayes  
Legal Assistant

**Confirmation Respectfully Requested**

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<b>AMENDMENT TRANSMITTAL LETTER</b>				Attorney Docket No: TSM03-0340		
Application Serial Number: 10/706,156		Filing Date: November 12, 2003		Examiner: Douglas W. Owens		Group Art Unit: 2811
Invention: Integration Film Scheme for Copper / Low-k Interconnect						
TO THE COMMISSIONER OF PATENTS AND TRADEMARKS: Transmitted herewith is an amendment in the above-identified application. The fee has been calculated as shown below.						
<b>CLAIMS AS AMENDED</b>						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	NO. OF EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	59	MINUS	29	30	\$50	\$ 1500.00
INDEP. CLAIMS	10	MINUS	4	6	\$200	\$ 1200.00
_____ Petition is hereby made under 37 CFR 1.136(a) to extend the time for response to the Office Action of <u>12/15/2005</u> to and through _____, comprising an extension of the shortened statutory period of: <div style="display: flex; justify-content: space-around; margin-top: 10px;"> <div>           _____ one month (\$110)            _____ two months (\$400)         </div> <div>           _____ three months (\$920)            _____ four months (\$1,440)         </div> </div>						
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT</b>						<b>\$ 2700.00</b>
_____ Applicant claims small entity status. See 37 CFR 1.27. Therefore the fee amount shown above is reduced by one-half, and the resulting fee is: \$ _____. _____ A check in the amount of \$ _____ is attached. <u>  X  </u> Charge \$ 2700.00 to Deposit Account <u>50-1065</u> . <u>  X  </u> Charge any additional fees or credit any overpayments to Deposit Account <u>50-1065</u> . _____ No additional fee is required.						
<u>March 15, 2006</u> Date			 Roger C. Knapp Attorney for Applicants Reg. No. 46,836			

COMMUNICATION

MAR 15 2006

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Huang, *et al.* Docket No.: TSM03-0340  
Serial No.: 10/706,156 Art Unit: 2811  
Filed: November 12, 2003 Examiner: Owens, Douglas W.  
For: Integration Film Scheme for Copper/Low-k Interconnect

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Dear Sir:

Applicants respectfully request reconsideration of the claims in view of the following amendments and remarks, which are submitted as a full and complete response to the Examiner's Office Action dated December 15, 2005.

03/16/2006 HTECKLU1 00000055 501065 10706156

01 FC:1201 1200.00 DA  
02 FC:1202 1500.00 DA